

LinearL2™ Power MOSFET w/Extended FBSOA

N-Channel Enhancement Mode Avalanche Rated

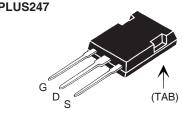
IXTK90N25L2 IXTX90N25L2



$V_{\scriptscriptstyle DSS}$	=	250V
1		004

 $R_{DS(an)} \leq 33m\Omega$

			TO-264
Test Conditions	Maximum Ratir	ngs	
Γ _J = 25°C to 150°C	250	V	A
$\Gamma_{\rm J} = 25^{\circ}{\rm C}$ to 150°C, ${\rm R_{GS}} = 1{\rm M}\Omega$	250	V	G D (TAB)
Continuous	±20	V	S (TAB)
Fransient	±30	V	
Г _с = 25°С	90	A	PI 119247
			PLUS747



G = Gate	D =	Drain
S = Source	TAB =	Drain

Features

- Designed for linear operation
- International standard packages
- Avalanche rated
- Guaranteed FBSOA at 75°C

Advantages

- Easy to mount
- Space savings
- High power density

Applications

- Solid state circuit breakers
- Soft start controls
- Linear amplifiers
- Programmable loads
- Current regulators

Symbol	Test Conditions	Maximum F	Ratings
V _{DSS}	$T_J = 25^{\circ}C$ to $150^{\circ}C$	250	V
\mathbf{V}_{DGR}	$T_{_J} = 25^{\circ}C$ to 150°C, $R_{_{GS}} = 1M\Omega$	250	V
V _{GSS}	Continuous	±20	V
V _{GSM}	Transient	±30	V
I _{D25}	T _c = 25°C	90	A
I _{DM}	$T_{c} = 25^{\circ}C$, pulse width limited by T_{JM}	360	Α
I _A	$T_c = 25^{\circ}C$	45	A
E _{AS}	$T_{c} = 25^{\circ}C$	3	J
P _D	$T_{c} = 25^{\circ}C$	960	W
T _J		-55+150	°C
T_{JM}		150	°C
T _{stg}		-55+150	°C
T _L	1.6mm (0.063 in.) from case for 10s	300	°C
T _{SOLD}	Plastic body for 10s	260	°C
M _d	Mounting torque (IXTK)	1.13/10	Nm/lb.in.
F _c	Mounting Force (IXTX)	20120 / 4.527	N/lb.
Weight	TO-264 PLUS247	10 6	g g

Symbol Test Conditions $(T_J = 25^{\circ}C, \text{ unless otherwise specified})$			racteris Typ.	stic Val Max.	
BV _{DSS}	$V_{GS} = 0V, I_D = 1mA$	250			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 3mA$	2.0		4.5	V
I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0V$ $T_{J} = 125^{\circ}C$			50 2.5	μA mA
R _{DS(on)}	V _{GS} = 10V, I _D = 0.5 • I _{D25} , Note 1			33	mΩ



Symbol (T _J = 25°C,	Test Conditions unless otherwise specified)	Ch Min.	aracteris Typ.	tic Values Max.
g _{fs}	V _{DS} = 10V, I _D = 0.5 • I _{D25} , Note 1	35	50	65 S
C _{iss}			23	nF
C _{oss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		2140	pF
C _{rss}			360	pF
t _{d(on)}	Resistive Switching Times		50	ns
t,	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		175	ns
t _{d(off)}	$R_{\rm G} = 1\Omega$ (External)		40	ns
t _f			160	ns
$Q_{g(on)}$			640	nC
Q _{gs}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		125	nC
Q_{gd}			385	nC
R _{thJC}				0.13 °C/W
R _{thCS}			0.15	°C/W

Safe Operating Area Specification

Symbol	ymbol Test Conditions		Characteristic Values		
		Min.	Тур.	Max.	
SOA	$V_{DS} = 250V, I_{D} = 2.3A, T_{C} = 75^{\circ}C, Tp = 5s$	575		W	

Source-Drain Diode

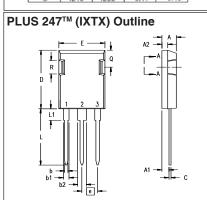
• • • • • • • • • • • • • • • • • • • •			aracteristic Values		
$(1_{J} = 25)$	°C, unless otherwise specified)	Min.	Тур.	Max	
I _s	$V_{GS} = 0V$			90	Α
SM	Repetitive, pulse width limited by T_{JM}			360	A
V _{sD}	$I_F = 45A$, $V_{GS} = 0V$, Note 1			1.5	V
t _{rr} I _{RM} Q _{RM}	$\begin{cases} I_F = 45A, -di/dt = 100A/\mu s, \\ V_R = 80V, V_{GS} = 0V \end{cases}$		266 23 3.0		ns A µC

Notes: 1. Pulse test, $t \le 300\mu s$; duty cycle, $d \le 2\%$.

PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

TO-264 (IXTK) Outline — A — | Ø Р Ф Ø К ® D В ® - GATE 4 - DRAIN (COLLECTOR) - SOURCE (EMITTER) SYM



Terminals:

- 2 Drain (Collector)
- 3 Source (Emitter)
- 4 Drain (Collector)

Dim.	Milli	meter	Inches		
	Min.	Max.	Min.	Max.	
Α	4.83	5.21	.190	.205	
A,	2.29	2.54	.090	.100	
A ₂	1.91	2.16	.075	.085	
b	1.14	1.40	.045	.055	
b ₁	1.91	2.13	.075	.084	
b ₂	2.92	3.12	.115	.123	
С	0.61	0.80	.024	.031	
D	20.80	21.34	.819	.840	
Е	15.75	16.13	.620	.635	
е	5.45	BSC	.215	BSC	
L	19.81	20.32	.780	.800	
L1	3.81	4.32	.150	.170	
Q	5.59	6.20	.220	0.244	
R	4.32	4.83	.170	.190	

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Fig. 1. Output Characteristics @ 25°C

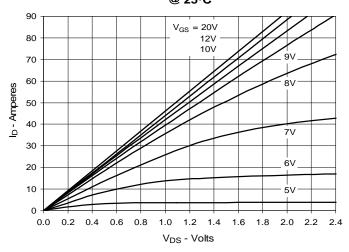


Fig. 2. Extended Output Characteristics @ 25°C

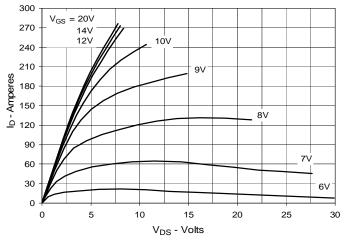


Fig. 3. Output Characteristics @ 125°C

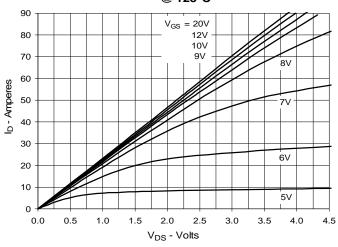


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 45A$ Value vs. Junction Temperature

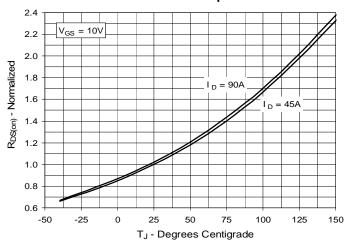


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 45A Value vs. Drain Current

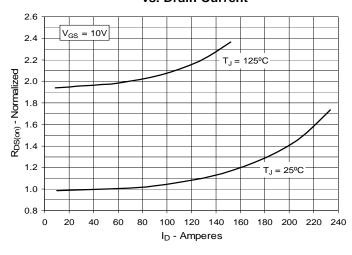
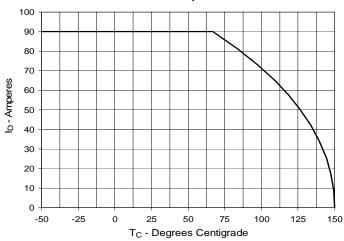


Fig. 6. Maximum Drain Current vs.

Case Temperature





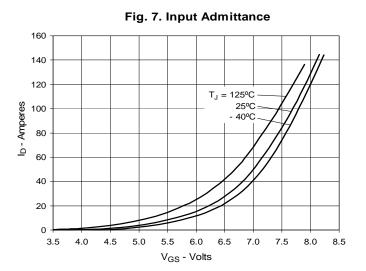
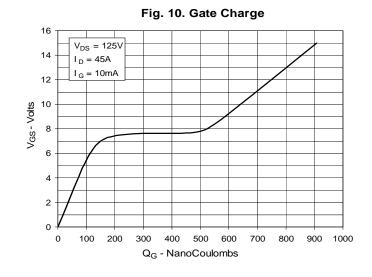
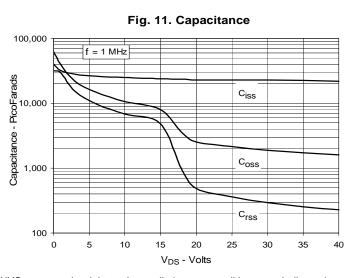


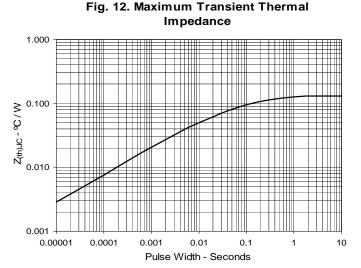
Fig. 8. Transconductance 120 110 100 90 80 gfs-Siemens 125°C 70 60 50 40 30 20 10 0 0 20 40 60 80 100 120 140

I_D - Amperes

Fig. 9. Forward Voltage Drop of **Intrinsic Diode** 280 240 200 ls - Amperes 150 150 80 $T_{J} = 125^{\circ}C$ 40 $T_{.J} = 25^{\circ}C$ 0 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 1.3 V_{SD} - Volts







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Fig. 13. Forward-Bias Safe Operating Area $@T_C = 25^{\circ}C$

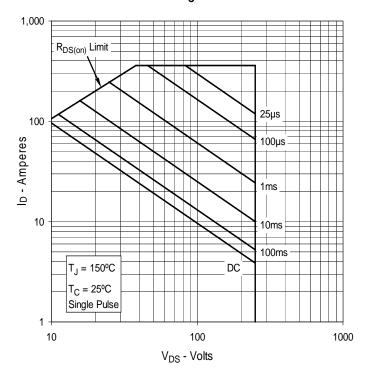


Fig. 14. Forward-Bias Safe Operating Area $@T_C = 75^{\circ}C$

